

P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)		
- 30	0.0125 at V_{GS} = - 10 V	- 11.6	22 nC		
	0.0180 at V_{GS} = - 4.5 V	- 10	22110		

S O SO-8 S 8 D 1 GC S D 7 2 S 3 6 D G D 5 4 D Top View P-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
 100 % UIS Tested

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs



COMPLIANT HALOGEN FREE Available

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		- 11.6	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C		- 10.5	
$Continuous Drain Current (1) = 150^{\circ} C)$	T _A = 25 °C		- 8.7 ^{a, b}	
	T _A = 70 °C		- 7.7 ^{a, b}	A
Pulsed Drain Current	I _{DM} - 40		A	
	T _C = 25 °C		- 4.6	
Continuous Source-Drain Diode Current	T _A = 25 °C	Is	2.0 ^{a, b}	
Avalanche Current	L 0.4 ml l	I _{AS}	- 20	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	20	mJ
	T _C = 25 °C		5.6	
Mariana Distinction	T _C = 70 °C		3.6	14/
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{a, b}	W
	T _A = 70 °C	1	1.6 ^{a, b}	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	39	50	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	18	22	C/VV	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W. d. Based on $T_C = 25$ °C.

SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static		·						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$ $I_D = -250 \mu A$			- 31		mV/°C		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- 1D = - 200 μA		5.5		mv/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA		
Zaro Cata Valtaga Drain Current	la e e	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μA		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge$ - 10 V, V_{GS} = - 10 V	- 30			А		
Desia Courses On State Desistence	Real	V _{GS} = - 10 V, I _D = - 10 A		0.011	0.0125	Ω		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 7 A		0.012	0.018			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 10 A		23		S		
Dynamic ^b								
Input Capacitance	C _{iss}			1960				
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		380		pF		
Reverse Transfer Capacitance	C _{rss}			325				
	Qg	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$		43	65	nC		
Total Gate Charge				22	33			
Gate-Source Charge	Q _{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$		6				
Gate-Drain Charge	Q _{gd}			11				
Gate Resistance	R _g	f = 1 MHz	0.3	1.3	2.5	Ω		
Turn-On Delay Time	t _{d(on)}			11	22			
Rise Time	t _r	V_{DD} = - 15 V, R_L = 3 Ω		13	25			
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 5 A, V_{GEN} = - 10 V, R_g = 1 Ω		32	50			
Fall Time	t _f			9	18	20		
Turn-On Delay Time	t _{d(on)}			44	70	ns		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 3 Ω		100	160			
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 5 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		28	50			
Fall Time	t _f			15	30			
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 4.6	А		
Pulse Diode Forward Current	I _{SM}				- 50	А		
Body Diode Voltage	V _{SD}	I _S = - 2 A, V _{GS} = 0 V		- 0.75	- 1.2	V		
Body Diode Reverse Recovery Time	t _{rr}			28	45	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	$1 - 2 \wedge dt/dt = 100 \wedge t_{10} T - 25 \circ C$		20	40	nC		
Reverse Recovery Fall Time	t _a	$I_F = -2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		13		ns		
Reverse Recovery Rise Time	t _b	1		15				

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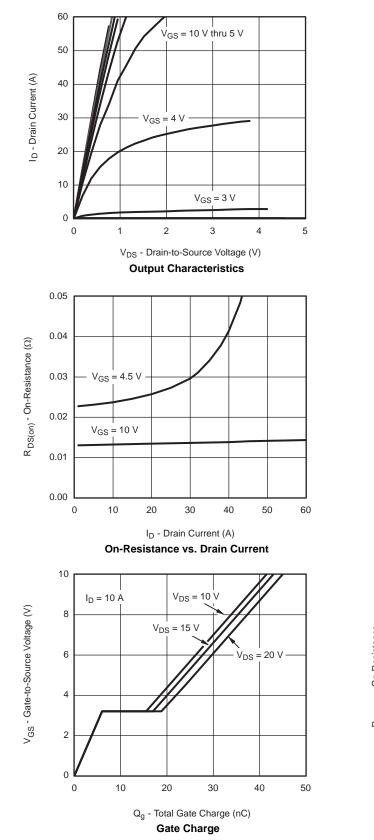
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

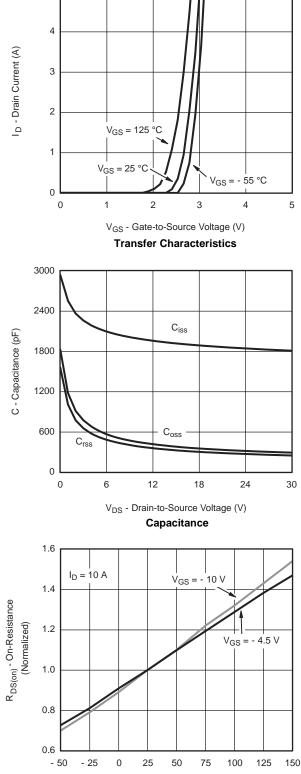
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

5



 $T_J = 125 \ ^\circ C$

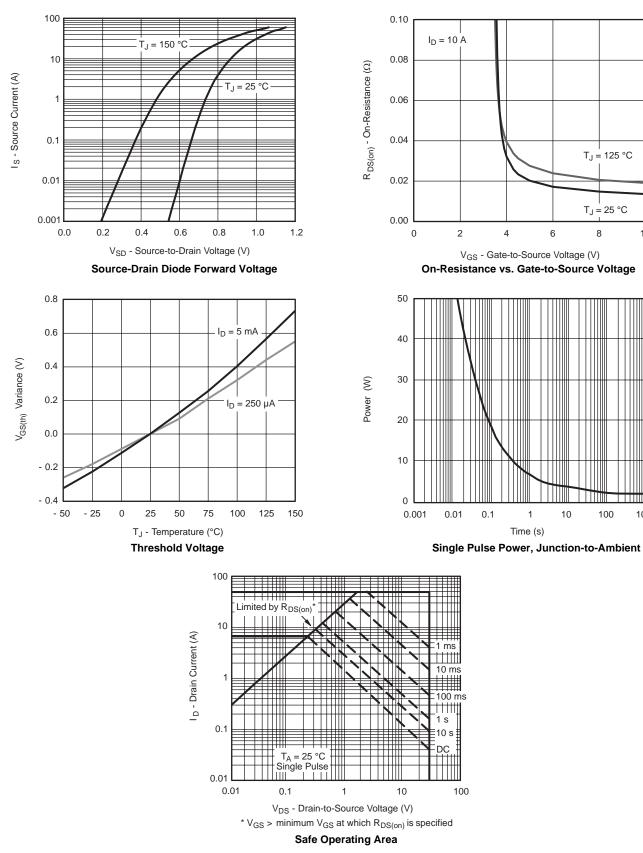
T_J = 25 °C

100

1000

10

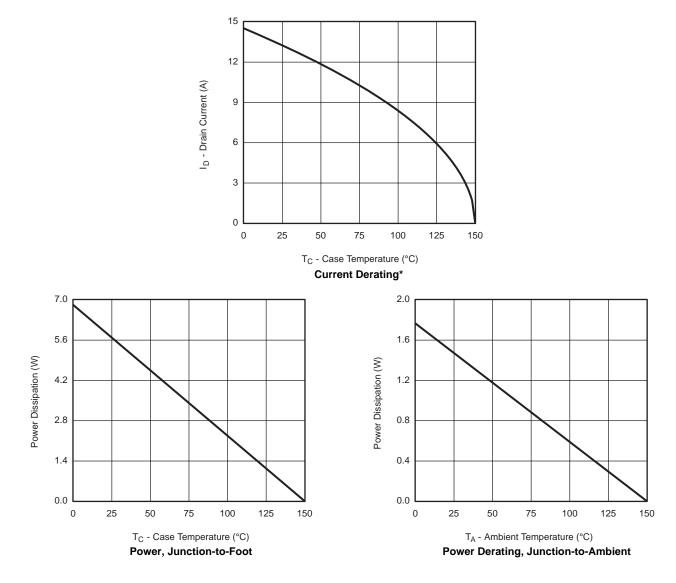
8



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



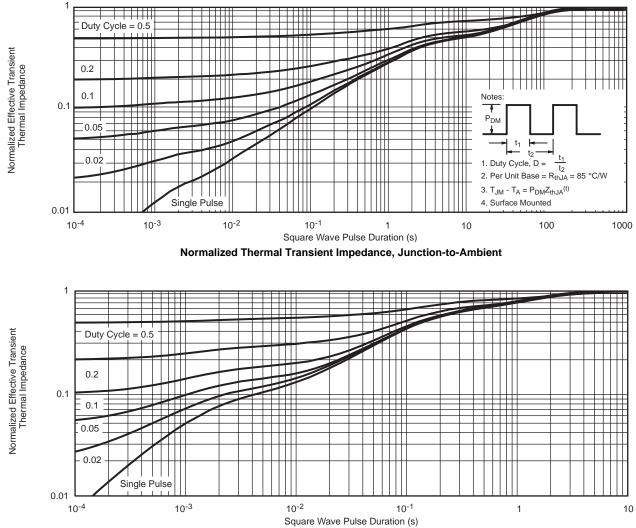
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





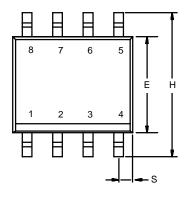


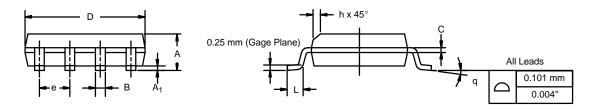
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

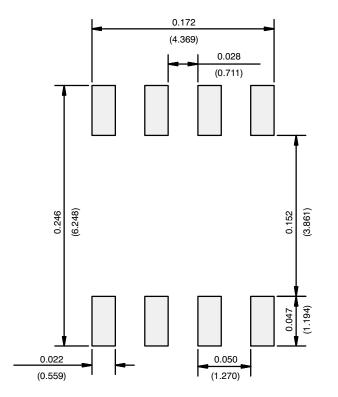




	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

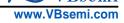


RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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